S12 MagniV S12ZVL

Smallest Integrated LIN Slave MCU

Product One-Sheet

Get Sample Data Sheet Tools

System in a Package – Highly integrated part ideal for space constrained applications such as actuators, sensors, LIN nodes, etc.

Low System Cost - Direct connection with battery, integrated LIN Phy, EVDD and NGPIOs reduce system, qualification and manufacturing cost.

High Reliability – High immunity to EMI and ESD stresses, LIN 2.x compliant with +/- 8kV ESD capability.

Enablement – Supported by comprehensive hardware and software system (free low-level drivers to enterprise 3rd party tools) which reduces development costs and time to market.

S12ZVL Specifications

Flash EEPROM	8–128 KB, 2 KB	Timer/ PWM	8 ch. + 4 ch. 16-bit/ 8 ch. 16-bit
RAM	8 KB	12 V VREG	12 V/70 mA, 170 mA with external ballast
Core	S12Z	EVDD	1 ch. 5 V/20 mA (source)
Speed	32 MHz	NGPIO	3 ch. 5 V/25 mA (sink)
ADC	10 ch. 12-bit	SCI/SPI/I ² C	2/1/1
HVI	1	Packages	32LQFP, 32QFN, 48LQFP
LIN Phy	1	Op Range	5.5 V–18 V

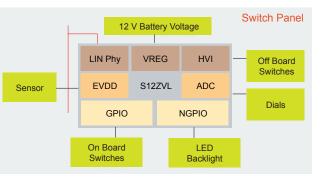
Part Numbers

32LQFP	32QFN-EP	48LQFP	
S912ZVLA12F0MLC	S912ZVLA12F0MFM	S912ZVLA12F0MLF	
S912ZVLA96F0MLC	S912ZVLA96F0MFM	S912ZVLA96F0MLF	
S912ZVLA64F0MLC	S912ZVLA64F0MFM	S912ZVLA64F0MLF	
S9S12ZVL32F0MLC	S9S12ZVLS3F0MFM	S9S12ZVL32F0MLF	
S9S12ZVL16F0MLC	S9S12ZVLS1F0MFM	S9S12ZVL16F0MLF	
S9S12ZVL8F0MLC	S9S12ZVLS8F0MFM	S9S12ZVL8F0MLF	

Block Diagram

Core	High Voltage Analog	Memories	System
S12Z 32 MHz Bus	12 V VREG	Flash (ECC)	CPMU
	LIN Physical Layer	128 KB	IPLL
DBG		DRG	EEPROM
	High Voltage	(ECC) 2 KB	XOSCLCP
BDC	Input	SRAM (ECC)	
	VSUP Sense	8 KB	
Analog	Timers	Comm. Interfaces	HMI
12-bit ADC	8 ch. TIM0	1x LIN Phy	GPIO
1x EVDD	4 ch. TIM1	2x SCI	KWU
3x NGPIO	API	1x IIC	IRQ
Temp Sense	RTI	1x SPI	
ACMP			
8-bit DAC	PWM	1x MSCAN	
PGA			

Switch Panel





Features

BAT 12 V ф

Operates from car battery

(i) Ultra-reliable industrial

Integrated LIN transceiver

Fast ADC

Success Stories

- LIN-based user-interface in Europe and Asia
- LIN-based immobilizer receiver in US
- LIN-based mirror control in Europe
- LIN-based airquality sensor in Europe

Target Applications

- LIN nodes
- LIN switch panel/user interface
- LIN actuators, sensors
- HVAC
- Lighting controls
- Ambient lighting
- Seat positioning
- Ultrasonic sensors

Enablement Tools

Evaluation boards/hardware

- TRK-S12ZVL
- DEVKIT-ZVL128
- DEVKIT-S127VL Q3-2016
- Reference solutions
- Ultrasonic distance measurement
- LIN RGB LED

CodeWarrior, Cosmic LIN drivers



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S12 MagniV Mixed-Signal **MCUs S12ZVL Family**

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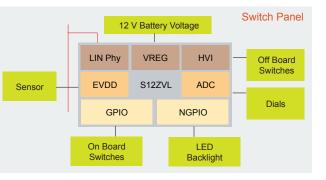
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S9S12ZVL32F0MLC	S9S12ZVLS3F0MFM	S9S12ZVL32F0MLF	
S9S12ZVL16F0MLC	S9S12ZVLS1F0MFM	S9S12ZVL16F0MLF	
S9S12ZVL8F0MLC	S9S12ZVLS8F0MFM	S9S12ZVL8F0MLF	

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